



Features:

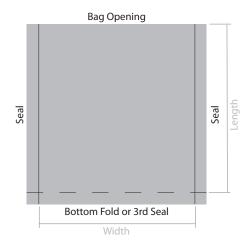
- Protects electronics from moisture and static damage
- Opaque and light tight ensuring the inside item can not been seen from outside
- Firm lamination and hot sealing offers superior resistance of vapour and oxygen
- Surface resistance of 10^8 - $10^{11}\Omega$
- Customized printing is available
- These bags are ideal for transporting and storing sensitive devices such as circuit boards and electronic components.
- Available in 3.6 / 4.4 and 6Mil thicknesses
- Flexible structure & easy to vacuum seal



| Aluminized Polyester | |
|----------------------|--|
| Dissipative Nylon | |
| Cast Polyethylene | |

Standard Construction:

Our moisture barrier bags are constructed in 3 layers. The bag features an anti static metallized polyester outer layer and an anti static inner layer. In between are layers of polyethylene, nylon and an aluminium foil shield.



Configuration(s):

Our bags are available in custom sizes or in several industry standard sizes. Bags are offered in a 3-seal configuration, with our standard flexographically printed artwork. Our bags can also be personalised with your company logo on any bespoke orders.

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Standard Bag Artwork:

Our moisture barrier bags are produced with the following sample artwork as standard. For further information on bespoke/printed orders, please contact one of our sales team. Please note there is a MOQ of 20,000 bags on all printed bags.

Note: All of our moisture barrier bags are batch coded for QC traceability.

| CAUTION This bag contains MOISTURE SENSITIVE DEVICES |
|--|
| If blank, see adjacent label 1. Calculated shelf life in sealed bag: 12 months at <40°C and <90% relative humidity (RH) |
| 2. Peak package body temperature:**C 3. After bag is opened, devices that will be subjected to reflow solder or other |
| high temperature process must: a) Mounted within hours of factory conditions <30°C / 60% RH_OR If blank, see adjacent label. |
| b) Stored at <10% RH |
| Devices require bake, before mounting, if: a) Humidity Indicator Card is > 10% when read at 23 +/-5°C b) 3a or 3b not met |
| 5. If baking is required, devices may be baked for 48 hours at 125 +/- 5°C |
| Note: If device containers cannot be subjected to high temperature or shorter bake times are desired, reference IPC/JEDEC J-STD-033 for bake procedure. |
| Bag Seal Date: |

| LEVEL | FLOOR LIFE (OUT OF THE BAG) AT FACTORY AMBIENT 30°C / 60% RH OR AS STATED | |
|-------|--|--|
| 1 | Unlimited at 30°C / 85% RH | |
| 2 | 1 Year | |
| 2a | 4 Weeks | |
| 3 | 168 Hours | |
| 4 | 72 Hours | |
| 5 | 48 Hours | |
| 5a | 24 Hours | |
| 6 | Mandatory bake before use. After bake must be reflowed within the time limit specified on the label. | |

MOISTURE BARRIER BAG



ATTENTION

THIS BAG CONTAINS MOISTURE & ELECTROSTATIC SENSITIVE DEVICES











CONFORMS TO IPC/JEDEC J-STD-033

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www.element14.com www.farnell.com www.newark.com





Test Conditions:

The following results were taken under the following environmental test conditions: Temperature: 21.3°C / Humidity: 45.1%



Technical Parameters:

| Item: | Test Standard: | Result: |
|---|------------------------------|--|
| Film Composition | N/A | PET-AL/NY/CPE |
| Metal Layer Resistance | ASTMD-257 | <0.1 Ω |
| Inner and Outer Resistance | ASTMD-257 | 10 ⁸ - 10 ¹¹ Ω |
| Static Shielding - Capacitance Probe | EIA541 (Voltage Difference) | <10V |
| Moisture Vapour Transmission (at 90%RH, 23°C) | ASTMF1249-2005 | 0.02 gm/100sq.in/24hrs |
| Tensile Strength | ASTM D882 | MD/TD >24lbs/in |
| Puncture Resistance | ASTM F1306-90(2002) | Inner to Outer: 54.7N Outer to Inner: 51.3N |
| Tear Strength | ASTM D1004 | MD >3lbs/in TD >3.8lbs/in |
| Heat Seal Temperature | - | 250-375 F |
| Heat Seal Time | - | 0.5-3.5 sec |
| Heat Seal Pressure | - | 30-70 PSI |
| Seal Strength | GB/96-04-10 | >3kg/cm |
| Contact Corrosivity | FTMS 101C Method 3005 | No visible spots detected |
| Static Decay Time | IEC61340-5-1 (±1000 - ±100V) | ≤2S |

Test Conclusion: (Date of Issue: 2009-08-16)

The anti-static moisture barrier bag is tested accordant with the relevant test standard and requirements.

| Test Item: | Test Method: | Measured Equipment(s): | MDL: |
|--|-----------------------------|------------------------|--------|
| Lead (Pb) | IEC 62321:2008 Ed.1 Sec.8 | ICP-OES | 2mg/kg |
| Cadmium (Cd) | IEC 62321:2008 Ed.1 Sec.8 | ICP-OES | 2mg/kg |
| Mercury (Hg) | IEC 62321:2008 Ed.1 Sec.7 | ICP-OES | 2mg/kg |
| Hexavalent Chromium (Cr(VI)) | IEC 62321:2008 Ed.1 Annex C | UV-Vis | 2mg/kg |
| Polybrominated Biphenyls (PBBs) | IEC 62321:2008 Ed.1 Annex A | GC-MS | 5mg/kg |
| Polybrominated Diphenyl Ethers (PBDEs) | IEC 62321:2008 Ed.1 Annex A | GC-MS | 5mg/kg |

EMI Shielding: Meets required range of EN 61340-5-1 tested per IEC 61340-2-3 and ANSI/ESD STM11.31

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| Product Code: | Description: | Size (inches): | Size (mm): | Additional Notes: |
|----------------------|--|----------------|---------------|-------------------|
| 2424330 | Moisture Barrier Bag 3.6Mil / 92 microns | 6 x 12 | 152.4 x 304.8 | Pack of 100 |

Note: Other sizes and thicknesses available upon request.

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